

Improve the appearance, content and clarity of the spec.

### DOCUMENT CHANGE REQUEST

502 DCR number Changes required for: General Originator: S Jeffery - ESCC Date: 2009/04/28 Date sent: 2009/04/28 Organisation: ESA/ESTEC Status: IMPLEMENTED Title: Transistors High Power NPN, based on type 2N5672 Number: 2 5203/004 Issue: Other documents affected: Page: See attached mark-up of 5203/004 (Issue 3 - Draft A). Note that this mark-up also includes the change of DCR 447 (DCR 447 was approved 16th December 2008); it is proposed that once this DCR has been approved, DCR 447 is introduced concurrently. Paragraph: See attached mark-up of 5203/004 (Issue 3 - Draft A). Note that this mark-up also includes the change of DCR 447 (DCR 447 was approved 16th December 2008); it is proposed that once this DCR has been approved, DCR 447 is introduced concurrently. Original wording: Proposed wording: To introduce a number of editorial and technical changes (see the attached mark-up) which are required to make this detail spec clear, complete and consistent with the standard format and content of specifications for similar Part Types. Justification:

Attachments:
5203004_Issue3Draft_A.pdf, null
Modifications:
Page 6: original Note 2 to Maximum Ratings, add ", and any handling,"between "testing" and "performed".
Approval signature:
Aboutes
Date signed:
2009-04-28

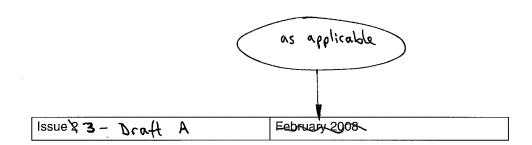


Pages 1 to 13

## TRANSISTORS, HIGH POWER, NPN

## **BASED ON TYPE 2N5672**

## ESCC Detail Specification No. 5203/004







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## **DOCUMENTATION CHANGE NOTICE**

(Refer to https://escies.org for ESCC DCR content)

DON NO.   C	HANGE DESCRIPTION	$\rightarrow$
187,364 S	pecification up issued to incorporate editorial and technical changes per po	CR <sub>4</sub> s.
447	TEN	

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Thermal Resistance, Junction-to-Case	Rth (j-c)	1.25	°c/W	1550E & 3
Characteristics	Symbols	Maximum Ratings	Unit	Remarks
Collector-Base Breakdown Volt- age	V <sub>(BR)CBO</sub>	150	V	Over T <sub>op</sub>
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	120	V	Over T <sub>op</sub>
Emitter-Base Breakdown Volt- age	V <sub>(BR)EBO</sub>	7	V	Over T <sub>op</sub>
Collector Current	Ic	30	Α	.,
Base Current	l <sub>B</sub>	10	Α	
Power Dissipation	P <sub>tot</sub>	140	W	At T <sub>case</sub> ≤ +25°C
Operating Temperature Range	T <sub>op</sub>	-65 to +200	°C	Note 🕱 🚹
Storage Temperature Range	T <sub>stg</sub>	-65 to +200	°C	Note 🦹 🐧
Soldering Temperature	T <sub>sol</sub>	+260	°C	Note 3 2

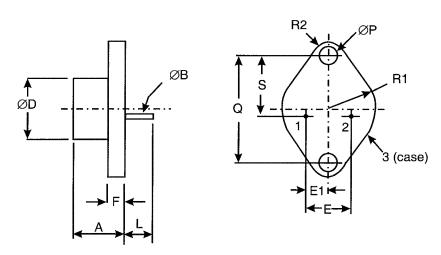
#### **NOTES:**

- For Trans > 25°C derate linearly to 0W at \$20000.

  For Variants with tin-lead plating or hot solder dip lead finish all testing performed at T<sub>amb</sub> > +125°C shall be carried out in a 100% inert atmosphere.
- Duration 10 seconds maximum at a distance of not less than 1.5mm from the device body and the same lead shall not be resoldered until 3 minutes have elapsed.

#### PHYSICAL DIMENSIONS AND TERMINAL IDENTIFICATION 1.6

Metal Flange Mount Package (TO-3) - 2 lead



Symbols	Dimensi	Notes	
Symbols	Min	Max	Notes
А	6.35	11.43	
ØB	0.97	1.09	2
ØD	-	22.23	



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Characteristics	Symbols		Limits		Units
		Drift Absolut		olute	
		Value Δ	Min	Max	
Collector-Emitter Cut-off Current	I <sub>CEO</sub>	±500	_	10000	μΑ
		or (1) ±100%			
Forward-Current Transfer Ratio 2	h <sub>FE2</sub>	±15%	20	100	-
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	±15%		750	mV

#### **NOTES:**

### 2.6 <u>INTERMEDIATE AND END-POINT ELECTRICAL MEASUREMENTS</u>

Unless otherwise specified, the measurements shall be performed at  $T_{amb}$ =+22 ±3°C.

The test methods and test conditions shall be as per the corresponding test defined in Room Temperature Electrical Measurements.

The limit values for each characteristic shall not be exceeded.

Characteristics	Symbols	Lin	Units	
		Min	Max	
Collector-Emitter Cut-off Current	I <sub>CEO</sub>	-	10	mA
Forward-Current Transfer Ratio 2	h <sub>FE2</sub>	20	100	-
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	-	750	mV

#### 2.7 POWER BURN-IN CONDITIONS

Symbols Conditions Characteristics Units ٥С Case Temperature +100 (+0 -5) T<sub>case</sub> As per Maximum Ratings Ptot **Power Dissipation** W  $P_{tot}$ derated at the specified Tcase  $V_{CB}$ 20 Collector-Base Voltage

#### 2.8 OPERATING LIFE CONDITIONS

The conditions shall be as specified for Power Burn-in.

nsing the specified Rth (j-c).

Derate

<sup>1.</sup> Whichever is greater, referred to the initial value.



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## APPENDIX 'A'

# AGREED DEVIATIONS FOR STMICROELECTRONICS (F)

ITEMS AFFECTED	DESCRIPTION OF DEVIATIONS
Deviations from Room Temperature Electrical Measurements	All AC characteristics (Room Temperature Electrical Measurement Note 2) may be considered guaranteed but not tested if successful pilot lot testing has been performed on the wafer lot which includes AC characteristic measurements per the Detail Specification.  A summary of the pilot lot testing shall be provided if required by the Purchase Order.
Deviations from High and Low Temperatures Electrical Measurements	All characteristics specified may be considered guaranteed but not tested if successful pilot lot testing has been performed on the wafer lot which includes characteristic measurements at high and low temperatures per the Detail Specification.  A summary of the pilot lot testing shall be provided if required by the Purchase Order.
Deviations from Screening Tests -	Solderability is not applicable unless specifically
Chart F3	stipulated in the Purchase Order.
VAINCE 1 3	

(Approved DCR 447 refers)